

Abstract for an Invited Paper  
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**Nanometer-scale properties of metal/oxide interfaces and “end-on” metal contacts to Si nanowires studied by ballistic electron emission microscopy (BEEM)<sup>1</sup>**

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BEEM is a hot-electron (HE) technique based on scanning tunneling microscopy that can probe buried metal/semiconductor and metal/dielectric interfaces with nm-scale spatial resolution and energy resolution of a few meV. BEEM is a three-terminal technique, so the HE energy and interface electric field can be varied independently. I will discuss two studies of interest for future transistor technologies. The first concerns the band structure and alignments in a 20 nm-thick film of the high-k dielectric material  $\text{Sc}_2\text{O}_3$  grown epitaxially on Si(111).  $\text{Sc}_2\text{O}_3$  and related rare-earth/transition metal oxide films on Si were found to have similar band alignments and bandgap, and also “tailing” conduction band (CB) states extending  $\sim 1$  eV below the primary CB. We combined BEEM with internal photoemission to measure the band alignment and to study electron transport through these “tail” states.<sup>2</sup> Surprisingly, these tail states were found to form a robust band of extended states that supports elastic hot-electron transport even *against* an applied electric field. The second study concerns HE injection and transport through “end-on” metal contacts made to  $\sim 100$  nm diameter vertical Si nanowires (NWs) embedded in a  $\text{SiO}_2$  dielectric. At low HE flux, We observed *lateral variations* of the local Schottky Barrier Height (SBH) across individual end-on Au Schottky contacts, with the SBH at the contact edge found to be  $\sim 25$  meV lower than at the contact center. Finite-element electrostatic simulations suggest that this is due to a larger interface electric field at the contact edge due to positively charged Si/native-oxide interface states near the Au/NW contact, with this (equilibrium) interface state charge induced by local band bending due to the high work function Au contact. We also observed a strong *suppression* of the hot-electron transmission efficiency at larger HE flux, likely due to (non-equilibrium) *steady-state negative charge accumulation* in metastable traps at the Si/oxide interface located near the injecting metal contact. Ongoing BEEM measurements of metal contacts to  $\text{SrTiO}_3$  substrates and films may also be discussed.

In collaboration with W. Cai, Y. Che, L. F. Edge, D. G. Schlom, E. R. Hemesath, and L. J. Lauhon.

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<sup>2</sup>W. Cai, S. E. Stone, J. P. Pelz, L. F. Edge, and D. G. Schlom, Appl. Phys. Lett **91**, 042901 (2007).